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LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT First Named Inventor: William D. Jensen

Filing Date: October 2, 2001 Group Art: 2814

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Examiner Initial		Document No.	Date	Name	Name Class		Filing Date If Appropriate	
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AC	AP	V. Ryan, Enhanced Stress-Migration Reliability for ULSI Interconnect: An Insight into the Perils of Screening Al Depositions Based on Grain Size, 1995				
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EXAMI	NER:	A lome Charalis	DATE CONSIDERED: $12/10/04$			

EXAMINER: DATE CONSIDERED: 12 10 104

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.